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## FCD1300N80Z N-Channel SuperFET<sup>®</sup> II MOSFET

**800 V, 4 A, 1.3** Ω

#### Features

- R<sub>DS(on)</sub> = 1.05 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 16.2 nC)
- Low E<sub>oss</sub> (Typ. 1.57 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 48.7 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

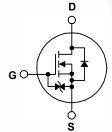
#### Applications

- AC DC Power Supply
- LED Lighting

## Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress.Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		FCD1300N80Z	Unit			
V <sub>DSS</sub>	Drain to Source Voltage	800	V			
V <sub>GSS</sub>		- DC		±20	- V	
	Gate to Source Voltage	- AC	±30			
	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	4	A		
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)	2.5			
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)			
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2			48	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)			0.8	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)			0.26	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt	20				
P <sub>D</sub>	Dawen Dissingtion	$(T_{\rm C} = 25^{\rm o}{\rm C})$		52	W	
	Power Dissipation	- Derate Above 25°C	0.42	W/ºC		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperat	-55 to +150	°C			
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

#### Thermal Characteristics

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Symbol	Parameter	FCD1300N80Z	Unit		
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.4	°C/W		
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	100	- °C/w		

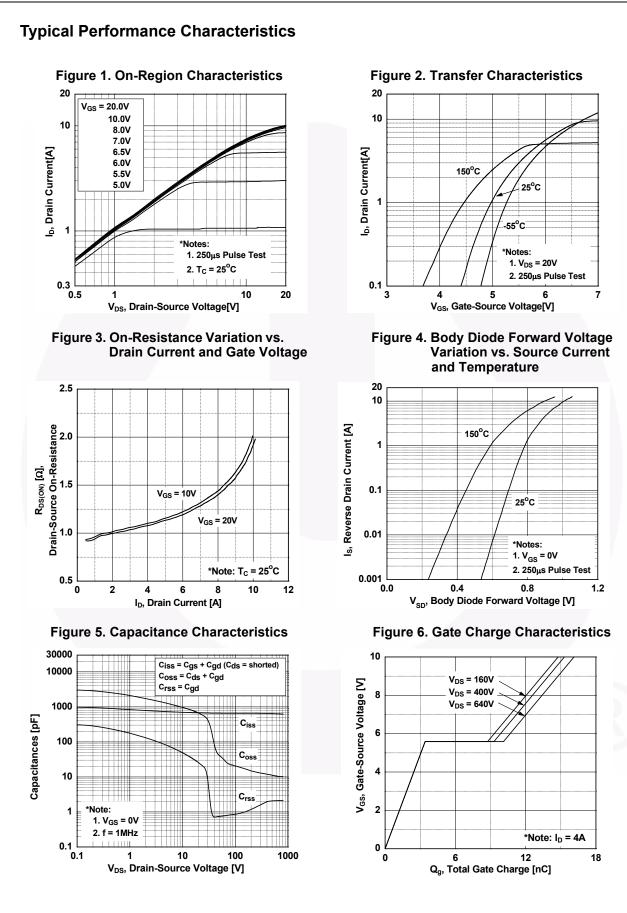
August 2014

Part Nu	ımber	Top Mark	Pack	kage	Packing Metho	d Reel S	ize	Tape Wid	lth	Quantity	
FCD1300N80Z		FCD130080Z	DP			330 m	ım	16 mm		2500 units	
Electrica	l Chara	icteristics T <sub>C</sub> = 25	<sup>o</sup> C unle	ess oth	erwise noted.		L		i		
Symbol		Parameter		Test Conditions			Min.	Тур.	Max	. Unit	
Off Chara	teristics	;									
BV <sub>DSS</sub>	Drain to S	Source Breakdown Volta	ige	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C			800	-	-	V	
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient			$I_D = 1$ mA, Referenced to 25°C			-	0.85	-	V/ºC	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current			$\frac{V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}}{V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_C = 125^{\circ}\text{C}}$			-	-	25	μA	
·D88							-	-	250	μι	
I <sub>GSS</sub>	Gate to Body Leakage Current			V <sub>GS</sub> =	±20 V, V <sub>DS</sub> = 0 V		-	-	±10	μA	
On Charao	teristics										
V <sub>GS(th)</sub>	Gate Thr	eshold Voltage		V <sub>GS</sub> =	V <sub>DS</sub> , I <sub>D</sub> = 0.4 mA		2.5	-	4.5	V	
R <sub>DS(on)</sub>	Static Dra	ain to Source On Resista	ance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2 \text{ A}$			-	1.05	1.3	Ω	
9 <sub>FS</sub>	Forward	Transconductance		$V_{\rm DS} = 20 \text{ V}, \text{ I}_{\rm D} = 2 \text{ A}$			-	4.5	-	S	
Dynamic (	Characte	ristics									
C <sub>iss</sub>	Input Cap			$V_{DS} = 100 V, V_{GS} = 0 V,$ f = 1 MHz $V_{DS} = 480 V, V_{GS} = 0 V, f = 1 MHz$		-	661	880	pF		
C <sub>oss</sub>	Output C	apacitance					22.3	30	pF		
C <sub>rss</sub>		Transfer Capacitance				-	0.74	-	pF		
C <sub>oss</sub>	Output C	apacitance				-	11.4	-	pF		
C <sub>oss(eff.)</sub>	Effective	Output Capacitance		$V_{DS} =$	0 V to 480 V, V <sub>GS</sub>	= 0 V	-	48.7	-	pF	
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V		$V_{DS} = 640 \text{ V}, \text{ I}_{D} = 4 \text{ A},$ $V_{GS} = 10 \text{ V}$		-	16.2	21	nC		
Q <sub>gs</sub>	Gate to S	Source Gate Charge				-	3.5	-	nC		
Q <sub>gd</sub>	Gate to D	Frain "Miller" Charge				(Note 4)	-	6.8	-	nC	
ESR	Equivaler	nt Series Resistance		f = 1 N	1Hz		-	4	-	Ω	
Switching	Charact	eristics									
t <sub>d(on)</sub>	1	Delay Time					-	14	38	ns	
t <sub>r</sub>		Rise Time		$V_{DD}$ = 400 V, I <sub>D</sub> = 4 A, $V_{GS}$ = 10 V, R <sub>g</sub> = 4.7 $\Omega$ (Note 4)			-	8.3	27	ns	
t <sub>d(off)</sub>		Delay Time				-		33	76	ns	
t <sub>f</sub>	Turn-Off					(Note 4)		6	22	ns	
	rce Diod	e Characteristics				. ,				7	
I <sub>S</sub>	T	Continuous Drain to Sc	ource Di	iode Fo	orward Current		-	-	4	А	
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current				-	-	12	A			
V <sub>SD</sub>		Source Diode Forward V					-	-	1.2	V	
t <sub>rr</sub>		Recovery Time		$V_{GS} = 0 V, I_{SD} = 4 A,$ dI <sub>F</sub> /dt = 100 A/µs			-	275	-	ns	
Q <sub>rr</sub>		Recovery Charge					-	2.9	-	μC	
lotes:		,		1						1 10	

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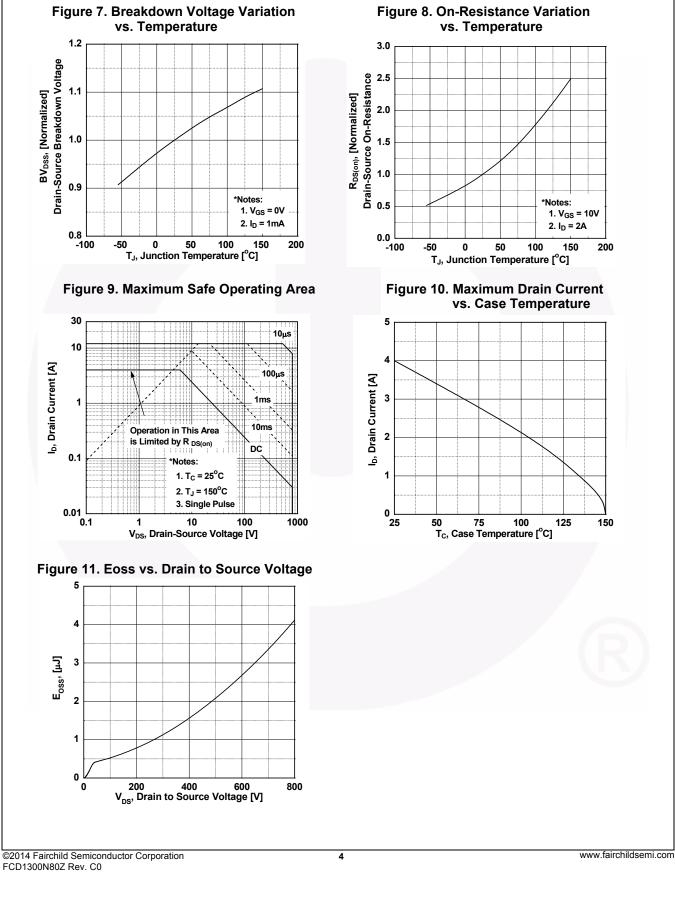
4. Essentially independent of operating temperature typical characteristic.

FCD1300N80Z — N-Channel SuperFET<sup>®</sup> II MOSFET

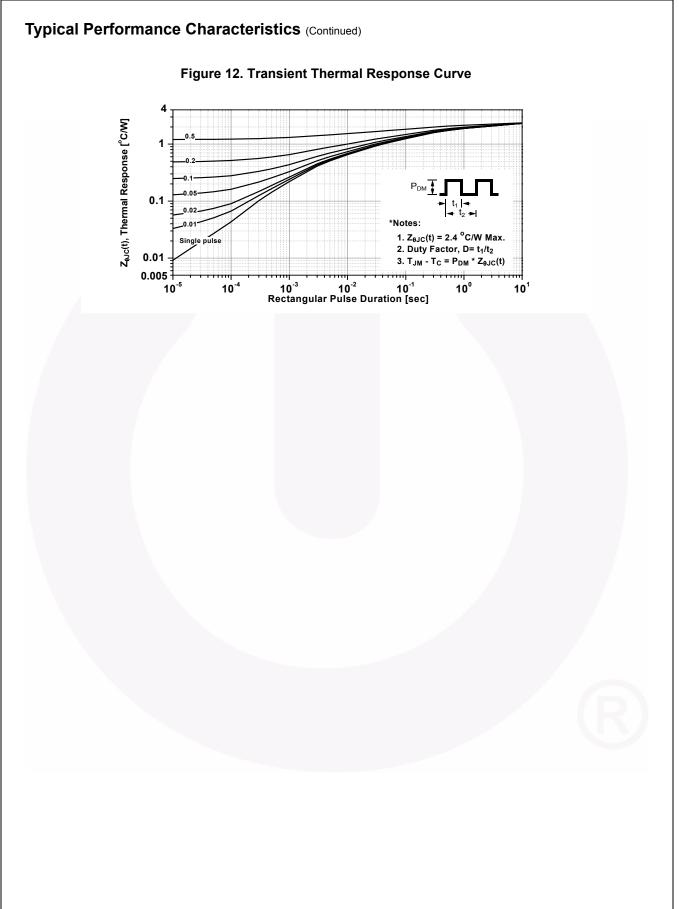


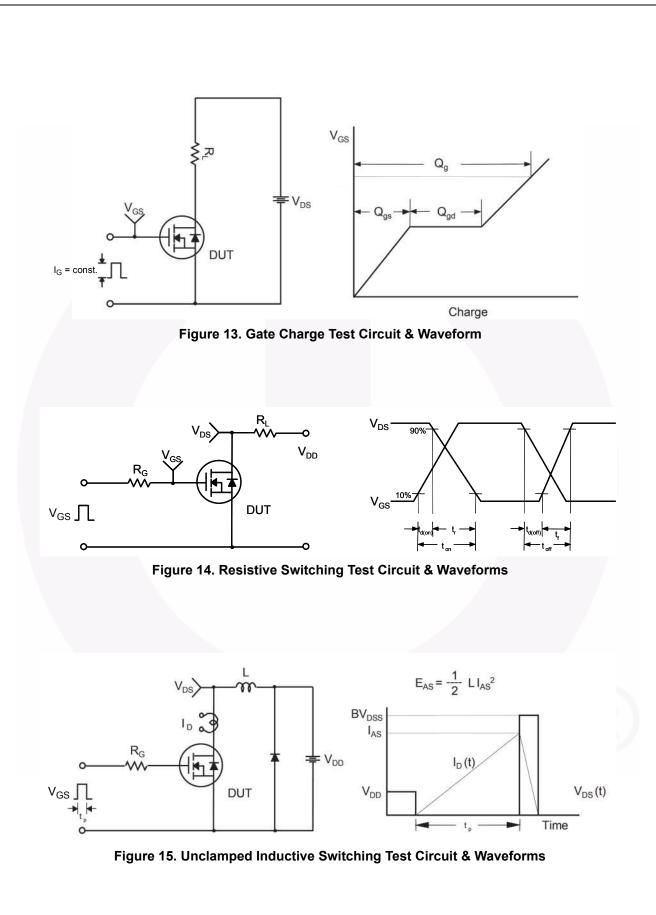
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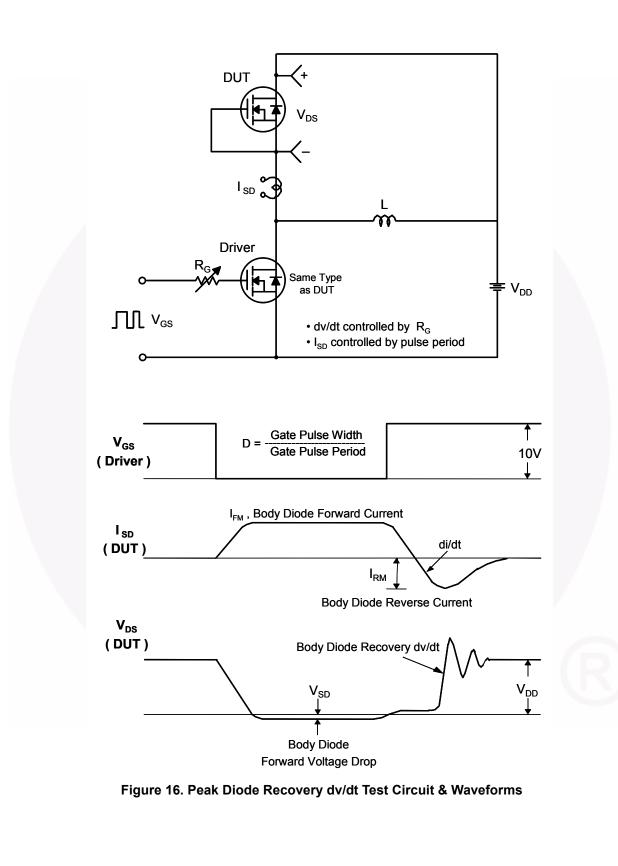


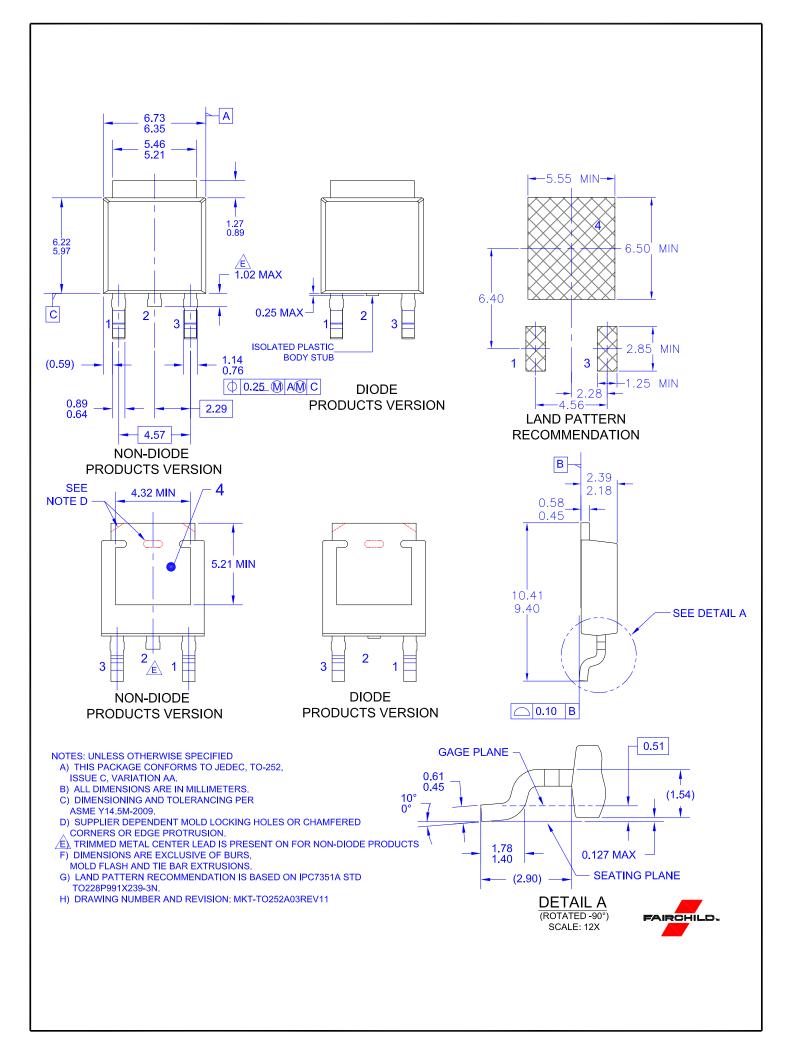
### Typical Performance Characteristics (Continued)





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